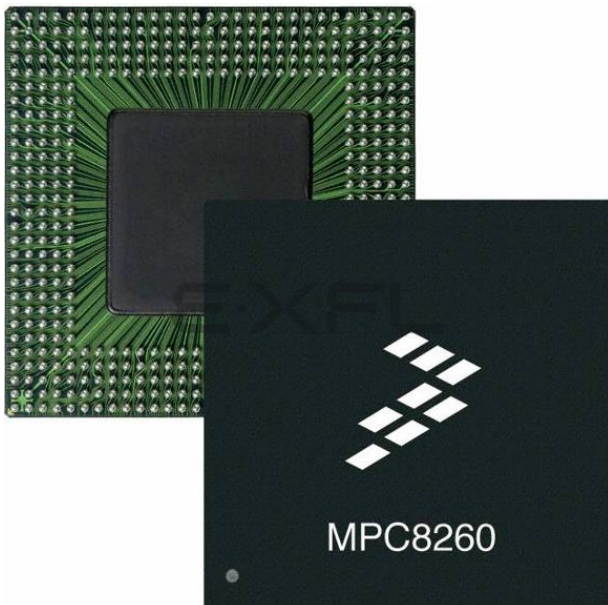




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Understanding [Embedded - Microprocessors](#)

Embedded microprocessors are specialized computing chips designed to perform specific tasks within an embedded system. Unlike general-purpose microprocessors found in personal computers, embedded microprocessors are tailored for dedicated functions within larger systems, offering optimized performance, efficiency, and reliability. These microprocessors are integral to the operation of countless electronic devices, providing the computational power necessary for controlling processes, handling data, and managing communications.

Applications of [Embedded - Microprocessors](#)

Embedded microprocessors are utilized across a broad spectrum of applications, making them indispensable in

Details

Product Status	Obsolete
Core Processor	PowerPC G2
Number of Cores/Bus Width	1 Core, 32-Bit
Speed	300MHz
Co-Processors/DSP	Communications; RISC CPM
RAM Controllers	DRAM, SDRAM
Graphics Acceleration	No
Display & Interface Controllers	-
Ethernet	10/100Mbps (3)
SATA	-
USB	-
Voltage - I/O	3.3V
Operating Temperature	0°C ~ 105°C (TA)
Security Features	-
Package / Case	480-LBGA Exposed Pad
Supplier Device Package	480-TBGA (37.5x37.5)
Purchase URL	https://www.e-xfl.com/product-detail/nxp-semiconductors/mpc8266avvpjdc

- PowerPC architecture-compliant memory management unit (MMU)
- Common on-chip processor (COP) test interface
- High-performance (6.6–7.65 SPEC95 benchmark at 300 MHz; 1.68 MIPS/MHz without inlining and 1.90 Dhrystones MIPS/MHz with
- Supports bus snooping for data cache coherency
- Floating-point unit (FPU)
- Separate power supply for internal logic and for I/O
- Separate PLLs for G2 core and for the CPM
 - G2 core and CPM can run at different frequencies for power/performance optimization
 - Internal core/bus clock multiplier that provides 1.5:1, 2:1, 2.5:1, 3:1, 3.5:1, 4:1, 5:1, 6:1 ratios
 - Internal CPM/bus clock multiplier that provides 2:1, 2.5:1, 3:1, 3.5:1, 4:1, 5:1, 6:1 ratios
- 64-bit data and 32-bit address 60x bus
 - Bus supports multiple master designs
 - Supports single- and four-beat burst transfers
 - 64-, 32-, 16-, and 8-bit port sizes controlled by on-chip memory controller
 - Supports data parity or ECC and address parity
- 32-bit data and 18-bit address local bus
 - Single-master bus, supports external slaves
 - Eight-beat burst transfers
 - 32-, 16-, and 8-bit port sizes controlled by on-chip memory controller
- 60x-to-PCI bridge (MPC8265 and MPC8266 only)
 - Programmable host bridge and agent
 - 32-bit data bus, 66 MHz, 3.3 V
 - Synchronous and asynchronous 60x and PCI clock modes
 - All internal address space available to external PCI host
 - DMA for memory block transfers
 - PCI-to-60x address remapping
- System interface unit (SIU)
 - Clock synthesizer
 - Reset controller
 - Real-time clock (RTC) register
 - Periodic interrupt timer
 - Hardware bus monitor and software watchdog timer
 - IEEE Std. 1149.1™ standard JTAG test access port
- Twelve-bank memory controller
 - Glueless interface to SRAM, page mode SDRAM, DRAM, EPROM, Flash and other user-definable peripherals
 - Byte write enables and selectable parity generation

- 32-bit address decodes with programmable bank size
- Three user programmable machines, general-purpose chip-select machine, and page-mode pipeline SDRAM machine
- Byte selects for 64 bus width (60x) and byte selects for 32 bus width (local)
- Dedicated interface logic for SDRAM
- CPU core can be disabled and the device can be used in slave mode to an external core
- Communications processor module (CPM)
 - Embedded 32-bit communications processor (CP) uses a RISC architecture for flexible support for communications protocols
 - Interfaces to G2 core through on-chip 32-Kbyte dual-port RAM and DMA controller
 - Serial DMA channels for receive and transmit on all serial channels
 - Parallel I/O registers with open-drain and interrupt capability
 - Virtual DMA functionality executing memory-to-memory and memory-to-I/O transfers
 - Three fast communications controllers supporting the following protocols (only FCC1 and FCC2 on the MPC8255):
 - 10/100-Mbit Ethernet/IEEE Std. 802.3® CDMA/CS interface through media independent interface (MII)
 - ATM—Full-duplex SAR protocols at 155 Mbps, through UTOPIA interface, AAL5, AAL1, AAL0 protocols, TM 4.0 CBR, VBR, UBR, ABR traffic types, up to 16 K external connections
 - Transparent
 - HDLC—Up to T3 rates (clear channel)
 - Two multichannel controllers (MCCs) (only MCC2 on the MPC8255)
 - Each MCC handles 128 serial, full-duplex, 64-Kbps data channels. Each MCC can be split into four subgroups of 32 channels each.
 - Almost any combination of subgroups can be multiplexed to single or multiple TDM interfaces up to four TDM interfaces per MCC
 - Four serial communications controllers (SCCs) identical to those on the MPC860, supporting the digital portions of the following protocols:
 - Ethernet/IEEE 802.3 CDMA/CS
 - HDLC/SDLC and HDLC bus
 - Universal asynchronous receiver transmitter (UART)
 - Synchronous UART
 - Binary synchronous (BISYNC) communications
 - Transparent
 - Two serial management controllers (SMCs), identical to those of the MPC860
 - Provide management for BRI devices as general circuit interface (GCI) controllers in time-division-multiplexed (TDM) channels

- Coset removing (programmable by the user)
- Filtering idle/unassigned cells (programmable by the user)
- Performing HEC error detection and single bit error correction (programmable by user)
- Generating loss of cell delineation status/interrupt (LOC/LCD)
- Operates with FCC2 (UTOPIA 8)
- Provides serial loop back mode
- Cell echo mode is provided
- Supports both FCC transmit modes
 - External rate mode—Idle cells are generated by the FCC (microcode) to control data rate.
 - Internal rate mode (sub-rate)—FCC transfers only the data cells using the required data rate. The TC layer generates idle/unassigned cells to maintain the line bit rate.
- Supports TC-layer and PMD-WIRE interface (according to the ATM-Forum af-phy-0063.000)
- Cell counters for performance monitoring
 - 16-bit counters count
 - HEC error cells
 - HEC single bit error and corrected cells
 - Idle/unassigned cells filtered
 - Idle/unassigned cells transmitted
 - Transmitted ATM cells
 - Received ATM cells
 - Maskable interrupt is sent to the host when a counter expires
- Overrun (Rx cell FIFO) and underrun (Tx cell FIFO) condition produces maskable interrupt
- May be operated at E1 and DS-1 rates. In addition, xDSL applications at bit rates up to 10 Mbps are supported
- PCI bridge (MPC8265 and MPC8266 only)
 - PCI Specification Revision 2.2 compliant and supports frequencies up to 66 MHz
 - On-chip arbitration
 - Support for PCI to 60x memory and 60x memory to PCI streaming
 - PCI Host Bridge or Peripheral capabilities
 - Includes 4 DMA channels for the following transfers:
 - PCI-to-60x to 60x-to-PCI
 - 60x-to-PCI to PCI-to-60x
 - PCI-to-60x to PCI-to-60x
 - 60x-to-PCI to 60x-to-PCI
 - Includes all of the configuration registers (which are automatically loaded from the EPROM and used to configure the MPC8265) required by the PCI standard as well as message and doorbell registers
 - Supports the I₂O standard

Table 3. DC Electrical Characteristics¹ (continued)

Characteristic	Symbol	Min	Max	Unit
$I_{OL} = 7.0 \text{ mA}$ $\overline{BR}$ $\overline{BG}$ $\overline{ABB/IRQ2}$ $\overline{TS}$ $A[0-31]$ $TT[0-4]$ $\overline{TBST}$ $TSIZE[0-3]$ $\overline{AACK}$ $\overline{ARTRY}$ $\overline{DBG}$ $\overline{DBB/IRQ3}$ $D[0-63]$ $DP(0)/\overline{RSRV/EXT_BR2}$ $DP(1)/\overline{IRQ1/EXT_BG2}$ $DP(2)/\overline{TLBISYNC/IRQ2/EXT_DBG2}$ $DP(3)/\overline{IRQ3/EXT_BR3/CKSTP_OUT}$ $DP(4)/\overline{IRQ4/EXT_BG3/CORE_SREST}$ $DP(5)/\overline{TBEN/IRQ5/EXT_DBG3}$ $DP(6)/\overline{CSE(0)/IRQ6}$ $DP(7)/\overline{CSE(1)/IRQ7}$ $\overline{PSDVAL}$ $\overline{TA}$ $\overline{TEA}$ $\overline{GBL/IRQ1}$ $\overline{CI/BADDR29/IRQ2}$ $\overline{WT/BADDR30/IRQ3}$ $\overline{L2_HIT/IRQ4}$ $\overline{CPU_BG/BADDR31/IRQ5}$ $\overline{CPU_DBG}$ $\overline{CPU_BR}$ $\overline{IRQ0/NMI_OUT}$ $\overline{IRQ7/INT_OUT/APE}$ $\overline{PORESET}$ $\overline{HRESET}$ $\overline{SRESET}$ $\overline{RSTCONF}$ $\overline{QREQ}$	V_{OL}	—	0.4	V

Table 8 lists CPM input characteristics.

Table 8. AC Characteristics for CPM Inputs¹

Spec Number		Characteristic	Setup (ns)		Hold (ns)	
Max	Min		66 MHz	83 MHz	66 MHz	83 MHz
sp16a	sp17a	FCC inputs—internal clock (NMSI)	10	8	0	0
sp16b	sp17b	FCC inputs—external clock (NMSI)	3	2.5	3	2
sp20	sp21	TDM inputs/SI	15	12	12	10
sp18a	sp19a	SCC/SMC/SPI/I2C inputs—internal clock (NMSI)	20	16	0	0
sp18b	sp19b	SCC/SMC/SPI/I2C inputs—external clock (NMSI)	5	4	5	4
sp22	sp23	PIO/TIMER/IDMA inputs	10	8	3	3

¹ Input specifications are measured from the 50% level of the signal to the 50% level of the rising edge of CLKIN. Timings are measured at the pin.

Note that although the specifications generally reference the rising edge of the clock, the following AC timing diagrams also apply when the falling edge is the active edge.

Figure 3 shows the FCC external clock.

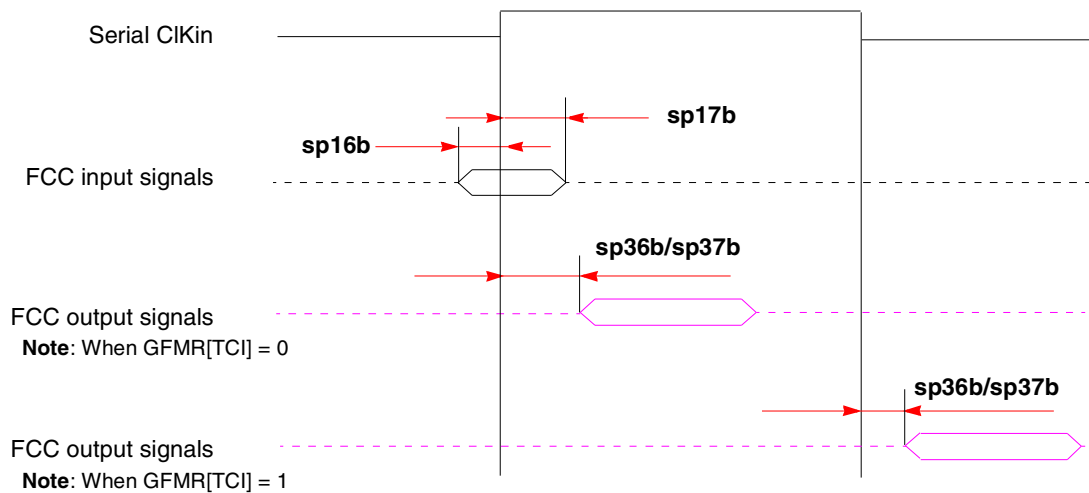


Figure 3. FCC External Clock Diagram

Figure 9 shows the interaction of several bus signals.

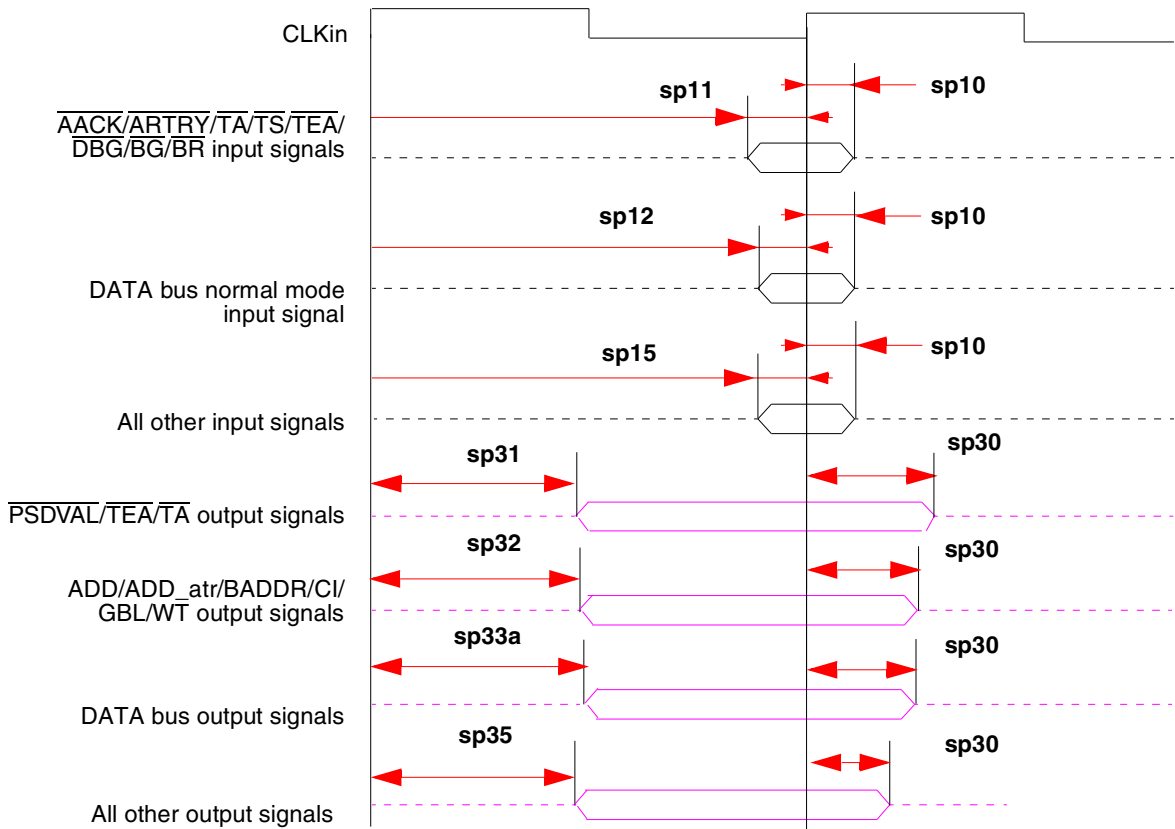


Figure 9. Bus Signals

Figure 10 shows signal behavior for all parity modes (including ECC, RMW parity, and standard parity).

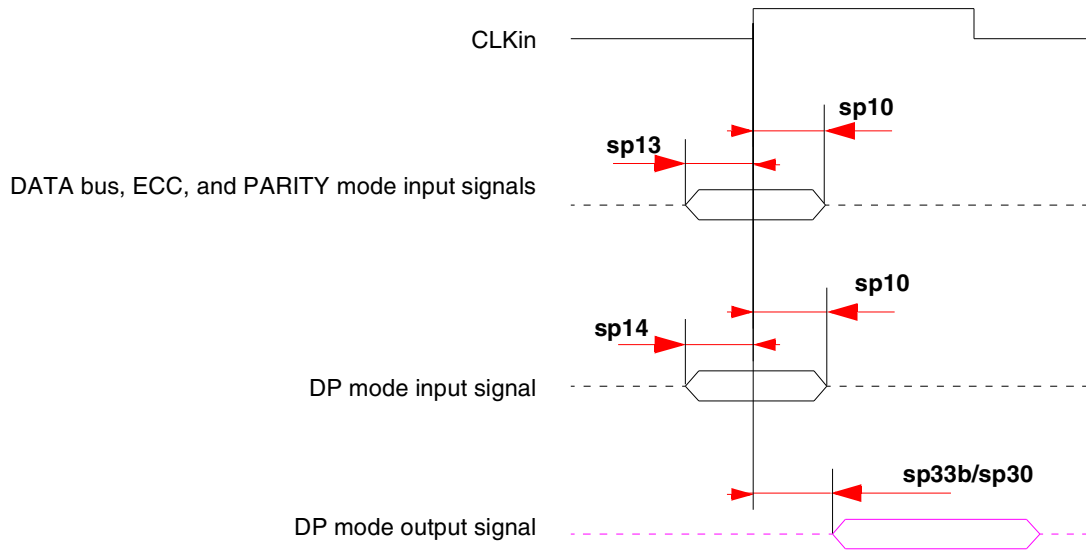


Figure 10. Parity Mode Diagram

3 Clock Configuration Modes

To configure the main PLL multiplication factor and the core, CPM, and 60x bus frequencies, the MODCK[1–3] pins are sampled while $\overline{\text{HRESET}}$ is asserted. Table 13 lists the eight basic configuration modes. Table 14 lists the other modes that are available by using the configuration pin ($\overline{\text{RSTCONF}}$) and driving four bits from hardware configuration word on the data bus.

Note that the MPC8265 and the MPC8266 have two additional clocking modes—PCI agent and PCI host. Refer to Section 3.2, “PCI Mode” on page 26 for information.

NOTE

Clock configurations change only after $\overline{\text{POR}}$ is asserted.

3.1 Local Bus Mode

Table 13 describes default clock modes for the MPC826xA.

Table 13. Clock Default Modes

MODCK[1–3]	Input Clock Frequency	CPM Multiplication Factor	CPM Frequency	Core Multiplication Factor	Core Frequency
000	33 MHz	3	100 MHz	4	133 MHz
001	33 MHz	3	100 MHz	5	166 MHz
010	33 MHz	4	133 MHz	4	133 MHz
011	33 MHz	4	133 MHz	5	166 MHz
100	66 MHz	2	133 MHz	2.5	166 MHz
101	66 MHz	2	133 MHz	3	200 MHz
110	66 MHz	2.5	166 MHz	2.5	166 MHz
111	66 MHz	2.5	166 MHz	3	200 MHz

Table 14 describes all possible clock configurations when using the hard reset configuration sequence. Note that basic modes are shown in boldface type. The frequencies listed are for the purpose of illustration only. Users must select a mode and input bus frequency so that the resulting configuration does not exceed the frequency rating of the user’s device.

Table 14. Clock Configuration Modes¹

MODCK_H–MODCK[1–3]	Input Clock Frequency ^{2,3}	CPM Multiplication Factor ²	CPM Frequency ²	Core Multiplication Factor ²	Core Frequency ²
0001_000	33 MHz	2	66 MHz	4	133 MHz
0001_001	33 MHz	2	66 MHz	5	166 MHz
0001_010	33 MHz	2	66 MHz	6	200 MHz
0001_011	33 MHz	2	66 MHz	7	233 MHz
0001_100	33 MHz	2	66 MHz	8	266 MHz

Table 14. Clock Configuration Modes¹ (continued)

MODCK_H–MODCK[1–3]	Input Clock Frequency ^{2,3}	CPM Multiplication Factor ²	CPM Frequency ²	Core Multiplication Factor ²	Core Frequency ²
0001_101	33 MHz	3	100 MHz	4	133 MHz
0001_110	33 MHz	3	100 MHz	5	166 MHz
0001_111	33 MHz	3	100 MHz	6	200 MHz
0010_000	33 MHz	3	100 MHz	7	233 MHz
0010_001	33 MHz	3	100 MHz	8	266 MHz
0010_010	33 MHz	4	133 MHz	4	133 MHz
0010_011	33 MHz	4	133 MHz	5	166 MHz
0010_100	33 MHz	4	133 MHz	6	200 MHz
0010_101	33 MHz	4	133 MHz	7	233 MHz
0010_110	33 MHz	4	133 MHz	8	266 MHz
0010_111	33 MHz	5	166 MHz	4	133 MHz
0011_000	33 MHz	5	166 MHz	5	166 MHz
0011_001	33 MHz	5	166 MHz	6	200 MHz
0011_010	33 MHz	5	166 MHz	7	233 MHz
0011_011	33 MHz	5	166 MHz	8	266 MHz
0011_100	33 MHz	6	200 MHz	4	133 MHz
0011_101	33 MHz	6	200 MHz	5	166 MHz
0011_110	33 MHz	6	200 MHz	6	200 MHz
0011_111	33 MHz	6	200 MHz	7	233 MHz
0100_000	33 MHz	6	200 MHz	8	266 MHz
0100_001	Reserved				
0100_010					
0100_011					
0100_100					
0100_101					
0100_110					

Table 14. Clock Configuration Modes¹ (continued)

MODCK_H–MODCK[1–3]	Input Clock Frequency ^{2,3}	CPM Multiplication Factor ²	CPM Frequency ²	Core Multiplication Factor ²	Core Frequency ²
0100_111	Reserved				
0101_000					
0101_001					
0101_010					
0101_011					
0101_100					
0101_101	66 MHz	2	133 MHz	2	133 MHz
0101_110	66 MHz	2	133 MHz	2.5	166 MHz
0101_111	66 MHz	2	133 MHz	3	200 MHz
0110_000	66 MHz	2	133 MHz	3.5	233 MHz
0110_001	66 MHz	2	133 MHz	4	266 MHz
0110_010	66 MHz	2	133 MHz	4.5	300 MHz
0110_011	66 MHz	2.5	166 MHz	2	133 MHz
0110_100	66 MHz	2.5	166 MHz	2.5	166 MHz
0110_101	66 MHz	2.5	166 MHz	3	200 MHz
0110_110	66 MHz	2.5	166 MHz	3.5	233 MHz
0110_111	66 MHz	2.5	166 MHz	4	266 MHz
0111_000	66 MHz	2.5	166 MHz	4.5	300 MHz
0111_001	66 MHz	3	200 MHz	2	133 MHz
0111_010	66 MHz	3	200 MHz	2.5	166 MHz
0111_011	66 MHz	3	200 MHz	3	200 MHz
0111_100	66 MHz	3	200 MHz	3.5	233 MHz
0111_101	66 MHz	3	200 MHz	4	266 MHz
0111_110	66 MHz	3	200 MHz	4.5	300 MHz
0111_111	66 MHz	3.5	233 MHz	2	133 MHz
1000_000	66 MHz	3.5	233 MHz	2.5	166 MHz

3.2.1 PCI Host Mode

The frequencies listed in [Table 16](#) and [Table 17](#) are for the purpose of illustration only. Users must select a mode and input bus frequency so that the resulting configuration does not exceed the frequency rating of the user's device.

Table 16. Clock Default Configurations in PCI Host Mode (MODCK_HI = 0000)

MODCK[1–3] ¹	Input Clock Frequency (Bus)	CPM Multiplication Factor	CPM Frequency	Core Multiplication Factor	Core Frequency	PCI Division Factor ²	PCI Frequency ²
000	66 MHz	2	133 MHz	2.5	166 MHz	2/4	66/33 MHz
001	66 MHz	2	133 MHz	3	200 MHz	2/4	66/33 MHz
010	66 MHz	2.5	166 MHz	3	200 MHz	3/6	55/28 MHz
011	66 MHz	2.5	166 MHz	3.5	233 MHz	3/6	55/28 MHz
100	66 MHz	2.5	166 MHz	4	266 MHz	3/6	55/28 MHz
101	66 MHz	3	200 MHz	3	200 MHz	3/6	66/33 MHz
110	66 MHz	3	200 MHz	3.5	233 MHz	3/6	66/33 MHz
111	66 MHz	3	200 MHz	4	266 MHz	3/6	66/33 MHz

¹ Assumes MODCK_HI = 0000.

² The frequency depends on the value of PCI_MODCK. If PCI_MODCK is high (logic '1'), the PCI frequency is divided by 2 (33 instead of 66 MHz, etc.) Refer to [Table 15](#).

[Table 17](#) describes all possible clock configurations when using the MPC8265's or the MPC8266's internal PCI bridge in host mode.

Table 17. Clock Configuration Modes in PCI Host Mode

MODCK_H – MODCK[1–3]	Input Clock Frequency ¹ (Bus)	CPM Multiplication Factor	CPM Frequency	Core Multiplication Factor	Core Frequency	PCI Division Factor ²	PCI Frequency ²
0001_000	33 MHz	3	100 MHz	5	166 MHz	3/6	33/16 MHz
0001_001	33 MHz	3	100 MHz	6	200 MHz	3/6	33/16 MHz
0001_010	33 MHz	3	100 MHz	7	233 MHz	3/6	33/16 MHz
0001_011	33 MHz	3	100 MHz	8	266 MHz	3/6	33/16 MHz
0010_000	33 MHz	4	133 MHz	5	166 MHz	4/8	33/16 MHz
0010_001	33 MHz	4	133 MHz	6	200 MHz	4/8	33/16 MHz
0010_010	33 MHz	4	133 MHz	7	233 MHz	4/8	33/16 MHz
0010_011	33 MHz	4	133 MHz	8	266 MHz	4/8	33/16 MHz
0011_000 ³	33 MHz	5	166 MHz	5	166 MHz	5	33 MHz
0011_001 ³	33 MHz	5	166 MHz	6	200 MHz	5	33 MHz
0011_010 ³	33 MHz	5	166 MHz	7	233 MHz	5	33 MHz

Table 17. Clock Configuration Modes in PCI Host Mode (continued)

MODCK_H – MODCK[1–3]	Input Clock Frequency ¹ (Bus)	CPM Multiplication Factor	CPM Frequency	Core Multiplication Factor	Core Frequency	PCI Division Factor ²	PCI Frequency ²
0011_011 ³	33 MHz	5	166 MHz	8	266 MHz	5	33 MHz
0100_000 ³	33 MHz	6	200 MHz	5	166 MHz	6	33 MHz
0100_001 ³	33 MHz	6	200 MHz	6	200 MHz	6	33 MHz
0100_010 ³	33 MHz	6	200 MHz	7	233 MHz	6	33 MHz
0100_011 ³	33 MHz	6	200 MHz	8	266 MHz	6	33 MHz
0101_000	66 MHz	2	133 MHz	2.5	166 MHz	2/4	66/33 MHz
0101_001	66 MHz	2	133 MHz	3	200 MHz	2/4	66/33 MHz
0101_010	66 MHz	2	133 MHz	3.5	233 MHz	2/4	66/33 MHz
0101_011	66 MHz	2	133 MHz	4	266 MHz	2/4	66/33 MHz
0101_100	66 MHz	2	133 MHz	4.5	300 MHz	2/4	66/33 MHz
0110_000	66 MHz	2.5	166 MHz	2.5	166 MHz	3/6	55/28 MHz
0110_001	66 MHz	2.5	166 MHz	3	200 MHz	3/6	55/28 MHz
0110_010	66 MHz	2.5	166 MHz	3.5	233 MHz	3/6	55/28 MHz
0110_011	66 MHz	2.5	166 MHz	4	266 MHz	3/6	55/28 MHz
0110_100	66 MHz	2.5	166 MHz	4.5	300 MHz	3/6	55/28 MHz
0111_000	66 MHz	3	200 MHz	2.5	166 MHz	3/6	66/33 MHz
0111_001	66 MHz	3	200 MHz	3	200 MHz	3/6	66/33 MHz
0111_010	66 MHz	3	200 MHz	3.5	233 MHz	3/6	66/33 MHz
0111_011	66 MHz	3	200 MHz	4	266 MHz	3/6	66/33 MHz
0111_100	66 MHz	3	200 MHz	4.5	300 MHz	3/6	66/33 MHz
1000_000	66 MHz	3	200 MHz	2.5	166 MHz	4/8	50/25 MHz
1000_001	66 MHz	3	200 MHz	3	200 MHz	4/8	50/25 MHz
1000_010	66 MHz	3	200 MHz	3.5	233 MHz	4/8	50/25 MHz
1000_011	66 MHz	3	200 MHz	4	266 MHz	4/8	50/25 MHz
1000_100	66 MHz	3	200 MHz	4.5	300 MHz	4/8	50/25 MHz
1001_000	66 MHz	3.5	233 MHz	2.5	166 MHz	4/8	58/29 MHz
1001_001	66 MHz	3.5	233 MHz	3	200 MHz	4/8	58/29 MHz

Table 18. Clock Default Configurations in PCI Agent Mode (MODCK_HI = 0000) (continued)

MODCK[1–3] ¹	Input Clock Frequency (PCI) ²	CPM Multiplication Factor ²	CPM Frequency	Core Multiplication Factor	Core Frequency ³	Bus Division Factor	60x Bus Frequency ⁴
100	66/33 MHz	3/6	200 MHz	3	240 MHz	2.5	80 MHz
101	66/33 MHz	3/6	200 MHz	3.5	280 MHz	2.5	80 MHz
110	66/33 MHz	4/8	266 MHz	3.5	300 MHz	3	88 MHz
111	66/33 MHz	4/8	266 MHz	3	300 MHz	2.5	100 MHz

¹ Assumes MODCK_HI = 0000.

² The frequency depends on the value of PCI_MODCK. If PCI_MODCK is high (logic '1'), the PCI frequency is divided by 2 (33 instead of 66 MHz, etc.) and the CPM multiplication factor is multiplied by 2. Refer to [Table 15](#).

³ Core frequency = (60x bus frequency)(core multiplication factor)

⁴ Bus frequency = CPM frequency/bus division factor

[Table 19](#) describes all possible clock configurations when using the MPC8265 or the MPC8266's internal PCI bridge in agent mode.

Table 19. Clock Configuration Modes in PCI Agent Mode

MODCK_H – MODCK[1–3]	Input Clock Frequency (PCI) ^{1,2}	CPM Multiplication Factor ¹	CPM Frequency	Core Multiplication Factor	Core Frequency ³	Bus Division Factor	60x Bus Frequency ⁴
0001_001	66/33 MHz	2/4	133 MHz	5	166 MHz	4	33 MHz
0001_010	66/33 MHz	2/4	133 MHz	6	200 MHz	4	33 MHz
0001_011	66/33 MHz	2/4	133 MHz	7	233 MHz	4	33 MHz
0001_100	66/33 MHz	2/4	133 MHz	8	266 MHz	4	33 MHz
0010_001	50/25 MHz	3/6	150 MHz	3	180 MHz	2.5	60 MHz
0010_010	50/25 MHz	3/6	150 MHz	3.5	210 MHz	2.5	60 MHz
0010_011	50/25 MHz	3/6	150 MHz	4	240 MHz	2.5	60 MHz
0010_100	50/25 MHz	3/6	150 MHz	4.5	270 MHz	2.5	60 MHz
0011_000	66/33 MHz	2/4	133 MHz	2.5	110MHz	3	44 MHz
0011_001	66/33 MHz	2/4	133 MHz	3	132 MHz	3	44 MHz
0011_010	66/33 MHz	2/4	133 MHz	3.5	154 MHz	3	44 MHz
0011_011	66/33 MHz	2/4	133 MHz	4	176MHz	3	44 MHz
0011_100	66/33 MHz	2/4	133 MHz	4.5	198 MHz	3	44 MHz
0100_000	66/33 MHz	3/6	200 MHz	2.5	166 MHz	3	66 MHz
0100_001	66/33 MHz	3/6	200 MHz	3	200 MHz	3	66 MHz
0100_010	66/33 MHz	3/6	200 MHz	3.5	233 MHz	3	66 MHz
0100_011	66/33 MHz	3/6	200 MHz	4	266 MHz	3	66 MHz

Table 19. Clock Configuration Modes in PCI Agent Mode (continued)

MODCK_H – MODCK[1–3]	Input Clock Frequency (PCI)^{1,2}	CPM Multiplication Factor¹	CPM Frequency	Core Multiplication Factor	Core Frequency³	Bus Division Factor	60x Bus Frequency⁴
0100_100	66/33 MHz	3/6	200 MHz	4.5	300 MHz	3	66 MHz
0101_000 ⁵	33 MHz	5	166 MHz	2.5	166 MHz	2.5	66 MHz
0101_001 ⁵	33 MHz	5	166 MHz	3	200 MHz	2.5	66 MHz
0101_010 ⁵	33 MHz	5	166 MHz	3.5	233 MHz	2.5	66 MHz
0101_011 ⁵	33 MHz	5	166 MHz	4	266 MHz	2.5	66 MHz
0101_100 ⁵	33 MHz	5	166 MHz	4.5	300 MHz	2.5	66 MHz
0110_000	50/25 MHz	4/8	200 MHz	2.5	166 MHz	3	66 MHz
0110_001	50/25 MHz	4/8	200 MHz	3	200 MHz	3	66 MHz
0110_010	50/25 MHz	4/8	200 MHz	3.5	233 MHz	3	66 MHz
0110_011	50/25 MHz	4/8	200 MHz	4	266 MHz	3	66 MHz
0110_100	50/25 MHz	4/8	200 MHz	4.5	300 MHz	3	66 MHz
0111_000	66/33 MHz	3/6	200 MHz	2	200 MHz	2	100 MHz
0111_001	66/33 MHz	3/6	200 MHz	2.5	250 MHz	2	100 MHz
0111_010	66/33 MHz	3/6	200 MHz	3	300 MHz	2	100 MHz
0111_011	66/33 MHz	3/6	200 MHz	3.5	350 MHz	2	100 MHz
1000_000	66/33 MHz	3/6	200 MHz	2	160 MHz	2.5	80 MHz
1000_001	66/33 MHz	3/6	200 MHz	2.5	200 MHz	2.5	80 MHz
1000_010	66/33 MHz	3/6	200 MHz	3	240 MHz	2.5	80 MHz
1000_011	66/33 MHz	3/6	200 MHz	3.5	280 MHz	2.5	80 MHz
1000_100	66/33 MHz	3/6	200 MHz	4	320 MHz	2.5	80 MHz
1000_101	66/33 MHz	3/6	200 MHz	4.5	360 MHz	2.5	80 MHz
1001_000	66/33 MHz	4/8	266 MHz	2.5	166 MHz	4	66 MHz
1001_001	66/33 MHz	4/8	266 MHz	3	200 MHz	4	66 MHz
1001_010	66/33 MHz	4/8	266 MHz	3.5	233 MHz	4	66 MHz
1001_011	66/33 MHz	4/8	266 MHz	4	266 MHz	4	66 MHz
1001_100	66/33 MHz	4/8	266 MHz	4.5	300 MHz	4	66 MHz
1010_000	66/33 MHz	4/8	266 MHz	2.5	222 MHz	3	88 MHz

Figure 14 shows the side profile of the TBGA package to indicate the direction of the top surface view.

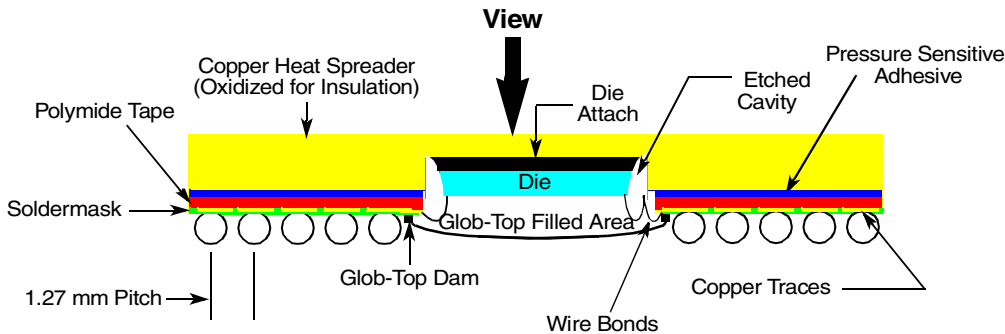


Figure 14. Side View of the TBGA Package

Table 21 shows the pinout list of the MPC826xA. Table 20 defines conventions and acronyms used in Table 21.

Symbols used in Table 21 are described in Table 20.

Table 20. Symbol Legend

Symbol	Meaning
OVERBAR	Signals with overbars, such as $\overline{TA}$, are active low.
UTM	Indicates that a signal is part of the UTOPIA master interface.
UTS	Indicates that a signal is part of the UTOPIA slave interface.
UT8	Indicates that a signal is part of the 8-bit UTOPIA interface.
UT16	Indicates that a signal is part of the 16-bit UTOPIA interface.
MII	Indicates that a signal is part of the media independent interface.

Table 21. Pinout List

Pin Name	Ball
BR	W5
BG	F4
ABB/IRQ2	E2
TS	E3
A0	G1
A1	H5
A2	H2
A3	H1
A4	J5
A5	J4
A6	J3
A7	J2

Table 21. Pinout List (continued)

Pin Name	Ball
A8	J1
A9	K4
A10	K3
A11	K2
A12	K1
A13	L5
A14	L4
A15	L3
A16	L2
A17	L1
A18	M5
A19	N5
A20	N4
A21	N3
A22	N2
A23	N1
A24	P4
A25	P3
A26	P2
A27	P1
A28	R1
A29	R3
A30	R5
A31	R4
TT0	F1
TT1	G4
TT2	G3
TT3	G2
TT4	F2
TBST	D3
TSIZ0	C1
TSIZ1	E4
TSIZ2	D2
TSIZ3	F5
AACK	F3

Table 21. Pinout List (continued)

Pin Name	Ball
IRQ3/DP3/CKSTP_OUT/EXT_BR3	D21
IRQ4/DP4/CORE_SRESET/EXT_BG3	C21
IRQ5/DP5/TBEN/EXT_DBG3	B21
IRQ6/DP6/CSE0	A21
IRQ7/DP7/CSE1	E20
PSDVAL	V3
TA	C22
TEA	V5
GBL/IRQ1	W1
C $\bar{I}$ /BADDR29/IRQ2	U2
WT/BADDR30/IRQ3	U3
L2_HIT/IRQ4	Y4
CPU_BG/BADDR31/IRQ5	U4
CPU_DBG	R2
CPU_BR	Y3
CS0	F25
CS1	C29
CS2	E27
CS3	E28
CS4	F26
CS5	F27
CS6	F28
CS7	G25
CS8	D29
CS9	E29
CS10/BCTL1	F29
CS11/AP0	G28
BADDR27	T5
BADDR28	U1
ALE	T2
BCTL0	A27
PWE0/PSDDQM0/PBS0	C25
PWE1/PSDDQM1/PBS1	E24
PWE2/PSDDQM2/PBS2	D24
PWE3/PSDDQM3/PBS3	C24

Table 21. Pinout List (continued)

Pin Name	Ball
PWE4/PSDDQM4/PBS4	B26
PWE5/PSDDQM5/PBS5	A26
PWE6/PSDDQM6/PBS6	B25
PWE7/PSDDQM7/PBS7	A25
PSDA10/PGPL0	E23
PSDWE/PGPL1	B24
POE/PSDRAS/PGPL2	A24
PSDCAS/PGPL3	B23
PGTA/PUPMWAIT/PGPL4/PPBS	A23
PSDAMUX/PGPL5	D22
LWE0/LSDDQM0/LBS0/PCI_CFG0 ¹	H28
LWE1/LSDDQM1/LBS1/PCI_CFG1 ¹	H27
LWE2/LSDDQM2/LBS2/PCI_CFG2 ¹	H26
LWE3/LSDDQM3/LBS3/PCI_CFG3 ¹	G29
LSDA10/LGPL0/PCI_MODCKH0 ¹	D27
LSDWE/LGPL1/PCI_MODCKH1 ¹	C28
LOE/LSDRAS/LGPL2/PCI_MODCKH2 ¹	E26
LSDCAS/LGPL3/PCI_MODCKH3 ¹	D25
LGTA/LUPMWAIT/LGPL4/LPBS	C26
LGPL5/LSDAMUX/PCI_MODCK ¹	B27
LWR	D28
L_A14/PAR ¹	N27
L_A15/FRAME ¹ /SMI	T29
L_A16/TRDY ¹	R27
L_A17/IRDY ¹ /CKSTP_OUT	R26
L_A18/STOP ¹	R29
L_A19/DEVSEL ¹	R28
L_A20/IDSEL ¹	W29
L_A21/PERR ¹	P28
L_A22/SERR ¹	N26
L_A23/REQ0 ¹	AA27
L_A24/REQ1 ¹ /HSEJSW ¹	P29
L_A25/GNT0 ¹	AA26
L_A26/GNT1 ¹ /HSLED ¹	N25
L_A27/GNT2 ¹ /HSENUM ¹	AA25

Table 21. Pinout List (continued)

Pin Name	Ball
PA12/FCC1_UT8_RXD2/FCC1_UT16_RXD10/MSNUM3	AJ21 ²
PA13/FCC1_UT8_RXD3/FCC1_UT16_RXD11/MSNUM2	AH20 ²
PA14/FCC1_UT8_RXD4/FCC1_UT16_RXD12/FCC1_RXD3	AG19 ²
PA15/FCC1_UT8_RXD5/FCC1_UT16_RXD13/FCC1_RXD2	AF18 ²
PA16/FCC1_UT8_RXD6/FCC1_UT16_RXD14/FCC1_RXD1	AF17 ²
PA17/FCC1_UT8_RXD7/FCC1_UT16_RXD15/FCC1_RXD0/FCC1_RXD	AE16 ²
PA18/FCC1_UT8_TXD7/FCC1_UT16_TXD15/FCC1_TXD0/FCC1_TXD	AJ16 ²
PA19/FCC1_UT8_TXD6/FCC1_UT16_TXD14/FCC1_TXD1	AG15 ²
PA20/FCC1_UT8_TXD5/FCC1_UT16_TXD13/FCC1_TXD2	AJ13 ²
PA21/FCC1_UT8_TXD4/FCC1_UT16_TXD12/FCC1_TXD3	AE13 ²
PA22/FCC1_UT8_TXD3/FCC1_UT16_TXD11	AF12 ²
PA23/FCC1_UT8_TXD2/FCC1_UT16_TXD10	AG11 ²
PA24/FCC1_UT8_TXD1/FCC1_UT16_TXD9/MSNUM1	AH9 ²
PA25/FCC1_UT8_TXD0/FCC1_UT16_TXD8/MSNUM0	AJ8 ²
PA26/FCC1_UTM_RXCLAV/FCC1_UTS_RXCLAV/FCC1_MII_RX_ER	AH7 ²
PA27/FCC1_UT_RXSOC/FCC1_MII_RX_DV	AF7 ²
PA28/FCC1_UTM_RXENB/FCC1_UTS_RXENB/FCC1_MII_TX_EN	AD5 ²
PA29/FCC1_UT_TXSOC/FCC1_MII_TX_ER	AF1 ²
PA30/FCC1_UTM_TXCLAV/FCC1_UTS_TXCLAV/FCC1_MII_CRS/ FCC1_RTS	AD3 ²
PA31/FCC1_UTM_TXENB/FCC1_UTS_TXENB/FCC1_MII_COL	AB5 ²
PB4/FCC3_TXD3/FCC2_UT8_RXD0/L1RSYNCA2/FCC3_RTS	AD28 ²
PB5/FCC3_TXD2/FCC2_UT8_RXD1/L1TSYNCA2/L1GNTA2	AD26 ²
PB6/FCC3_TXD1/FCC2_UT8_RXD2/L1RXDA2/L1RXD0A2	AD25 ²
PB7/FCC3_TXD0/FCC3_TXD/FCC2_UT8_RXD3/L1TXDA2/L1TXD0A2	AE26 ²
PB8/FCC2_UT8_TXD3/FCC3_RXD0/FCC3_RXD/TXD3/L1RSYNCD1	AH27 ²
PB9/FCC2_UT8_TXD2/FCC3_RXD1/L1TXD2A2/L1TSYNCD1/L1GNTD1	AG24 ²
PB10/FCC2_UT8_TXD1/FCC3_RXD2/L1RXDD1	AH24 ²
PB11/FCC3_RXD3/FCC2_UT8_TXD0/L1TXDD1	AJ24 ²
PB12/FCC3_MII_CRS/L1CLKOB1/L1RSYNCC1/TXD2	AG22 ²
PB13/FCC3_MII_COL/L1RQB1/L1TSYNCC1/L1GNTC1/L1TXD1A2	AH21 ²
PB14/FCC3_MII_TX_EN/RXD3/L1RXDC1	AG20 ²
PB15/FCC3_MII_TX_ER/RXD2/L1TXDC1	AF19 ²
PB16/FCC3_MII_RX_ER/L1CLKOA1/CLK18	AJ18 ²
PB17/FCC3_MII_RX_DV/L1RQA1/CLK17	AJ17 ²

Table 21. Pinout List (continued)

Pin Name	Ball
PB18/FCC2_UT8_RXD4/FCC2_RXD3/L1CLKOD2/L1RXD2A2	AE14 ²
PB19/FCC2_UT8_RXD5/FCC2_RXD2/L1RQD2/L1RXD3A2	AF13 ²
PB20/FCC2_UT8_RXD6/FCC2_RXD1/L1RSYNCD2/L1TXD1A1	AG12 ²
PB21/FCC2_UT8_RXD7/FCC2_RXD0/FCC2_RXD/L1TSYNCD2/L1GNTD2/L1TXD2A1	AH11 ²
PB22/FCC2_UT8_TXD7/FCC2_TXD0/FCC2_TXD/L1RXD1A1/L1RXDD2	AH16 ²
PB23/FCC2_UT8_TXD6/FCC2_TXD1/L1RXD2A1/L1TXDD2	AE15 ²
PB24/FCC2_UT8_TXD5/FCC2_TXD2/L1RXD3A1/L1RSYNCC2	AJ9 ²
PB25/FCC2_UT8_TXD4/FCC2_TXD3/L1TSYNCC2/L1GNTC2/L1TXD3A1	AE9 ²
PB26/FCC2_MII_CRD/FCC2_UT8_TXD1/L1RXDC2	AJ7 ²
PB27/FCC2_MII_COL/FCC2_UT8_TXD0/L1TXDC2	AH6 ²
PB28/FCC2_MII_RX_ER/FCC2_RTS/L1TSYNCB2/L1GNTB2/TXD1	AE3 ²
PB29/FCC2_UTM_RXCLAV/FCC2_UTS_RXCLAV/L1RSYNCB2/FCC2_MII_TX_EN	AE2 ²
PB30/FCC2_MII_RX_DV/FCC2_UT_TXSOC/L1RXDB2	AC5 ²
PB31/FCC2_MII_TX_ER/FCC2_UT_RXSOC/L1TXDB2	AC4 ²
PC0/DREQ1/BRGO7/SMSYN2/L1CLKOA2	AB26 ²
PC1/DREQ2/BRGO6/L1RQA2	AD29 ²
PC2/FCC3_CD/FCC2_UT8_TXD3/DONE2	AE29 ²
PC3/FCC3_CTS/FCC2_UT8_TXD2/DACK2/CTS4	AE27 ²
PC4/FCC2_UTM_RXENB/FCC2_UTS_RXENB/SI2_L1ST4/FCC2_CD	AF27 ²
PC5/FCC2_UTM_TXCLAV/FCC2_UTS_TXCLAV/SI2_L1ST3/FCC2_CTS	AF24 ²
PC6/FCC1_CD/L1CLKOC1/FCC1_UTM_RXADDR2/FCC1_UTS_RXADDR/FCC1_UTM_RXCLAV1	AJ26 ²
PC7/FCC1_CTS/L1RQC1/FCC1_UTM_TXADDR2/FCC1_UTS_TXADDR2/FCC1_UTM_TXCLAV1	AJ25 ²
PC8/CD4/RENA4/FCC1_UT16_TXD0/SI2_L1ST2/CTS3	AF22 ²
PC9/CTS4/CLSN4/FCC1_UT16_TXD1/SI2_L1ST1/L1TSYNCA2/L1GNTA2	AE21 ²
PC10/CD3/RENA3/FCC1_UT16_TXD2/SI1_L1ST4/FCC2_UT8_RXD3	AF20 ²
PC11/CTS3/CLSN3/L1CLKOD1/L1TXD3A2/FCC2_UT8_RXD2	AE19 ²
PC12/CD2/RENA2/SI1_L1ST3/FCC1_UTM_RXADDR1/FCC1_UTS_RXADDR1	AE18 ²
PC13/CTS2/CLSN2/L1RQD1/FCC1_UTM_TXADDR1/FCC1_UTS_TXADDR1	AH18 ²
PC14/CD1/RENA1/FCC1_UTM_RXADDR0/FCC1_UTS_RXADDR0	AH17 ²
PC15/CTS1/CLSN1/SMTXD2/FCC1_UTM_TXADDR0/FCC1_UTS_TXADDR0	AG16 ²

Package Description

- ³ On PCI devices (MPC8265 and MPC8266) this pin should be used as CLKIN2. On non-PCI devices (MPC8260A and MPC8264) this is a spare pin that must be pulled down or left floating.
- ⁴ Must be pulled down or left floating.
- ⁵ On PCI devices (MPC8265 and MPC8266) this pin should be asserted if the PCI function is desired or pulled up or left floating if PCI is not desired. On non-PCI devices (MPC8260A and MPC8264) this is a spare pin that must be pulled up or left floating.
- ⁶ For information on how to use this pin, refer to *MPC8260 PowerQUICC II Thermal Resistor Guide* available at www.freescale.com.

5 Package Description

The following sections provide the package parameters and mechanical dimensions for the MPC826xA.

5.1 Package Parameters

Package parameters are provided in [Table 22](#). The package type is a 37.5 × 37.5 mm, 480-lead TBGA.

Table 22. Package Parameters

Parameter	Value
Package Outline	37.5 × 37.5 mm
Interconnects	480 (29 × 29 ball array)
Pitch	1.27 mm
Nominal unmounted package height	1.55 mm